



AMENDMENT TRANSMITTAL LETTER					Docket No. 0941-0946PUS1
Application No. 10/829,363-Conf. #7073		Filing Date April 22, 2004		Examiner H. V. Duong	Art Unit 2835
Applicant(s): Chir		April 22,	2004	11. V. Duong	
Applicant(s). Chi	I-Ollering Lity	<u> </u>			
nvention: HOUSI	NG STRUCTU	RE			
MS Amendment Commissioner for P.O. Box 1450 Alexandria, VA 223					
Transmitted here	with is an ame	ndment in the	above-identif	ed application.	
The fee has beer	n calculated and	d is transmitted	d as shown b	elow.	
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	Claims Remaining After Amendment	Highest Number Previously Paid	Number Extra Claims Present	Rate	
Total Claims	19	- 20 =		х	
Independent Claims	2	- 3 =		x	
Multiple Depend	dent Claims (ch	eck if applicabl	e)		
Other fee (pleas	e specify):		<u></u>		
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x No additiona		d for this amer	ndment	oman zmity	
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A check in the	ne amount of \$		is enclo	sed.	
Payment by	credit card. Fo	orm PTO-2038	is attached.		
	r is hereby auth d below. A dup			Deposit Account No enclosed.	o. <u>02-2448</u>
	ny overpaymer				
x Charge	any additional fili	ng or applicatio	n processing	fees required under 3	7 CFR 1.16 and 1.17.
Joe McKinney Attorney Reg. N				Dated:	June 12, 2006
	1	LAS DIDOLL LI	D		
BIRCH, STEW. 8110 Gatehous Suite 100 East P.O. Box 747		H& BIRCH, LI	LP		
Falls Church, V (703) 205-8026		0747			



Docket No.: 0941-0946PUS1

(PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Chin-Cheng LIN

Application No.: 10/829,363

Confirmation No.: 7073

Filed: April 22, 2004

Art Unit: 2835

For: HOUSING STRUCTURE

Examiner: H. V. Duong

AMENDMENT IN RESPONSE TO NON-FINAL OFFICE ACTION

MS Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

INTRODUCTORY COMMENTS

In reply to the Office Action dated March 10, 2006, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This reply includes:

Amendments to the Specification; and

Remarks.